

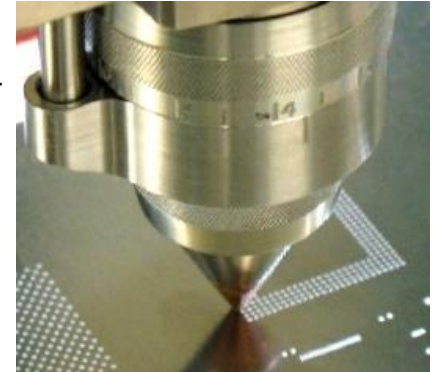
Micron Laser Technology

Subcontract Laser Services and Product Manufacturing

AS9100C / ISO9001:2008 Certified

Experience and Capabilities

- ▶ 18,000 sq. ft. facility with 20 laser drilling systems solely dedicated to microvia drilling, laser material processing, micro-machining, prototyping, and manufacturing solutions.
- ▶ 18+ years of laser process engineering for the **PCB, Aerospace, Defense, and Medical** industries in following applications:
 - ❑ Close Tolerance Routing
 - ❑ Laser Marking and Engraving
 - ❑ Stencils and Shadow Masks
 - ❑ Prototypes
 - ❑ Laser Welding
 - ❑ IPC HDI Microvia Drilling
 - ❑ Control Depth Cavity Formation
 - ❑ Selective Coatings/Film Removal
- ▶ 10 engineers/technologists skilled in laser processing of just about every known dielectric and reinforcement, metal, and plastic.
- ▶ Hybrid laser systems that incorporate up to 4 laser heads per system in both UV and IR wavelengths delivered in both fixed-beam (CNC), fiber, and galvos.
- ▶ Customized laser software that provides more energy control than standard OEM laser systems on the market capable of tolerances below 10um and feature sizes below 20um.



Parts Manufacturing

Turn a machining challenge into a manufacturing advantage. Laser advantages over traditional machining include:

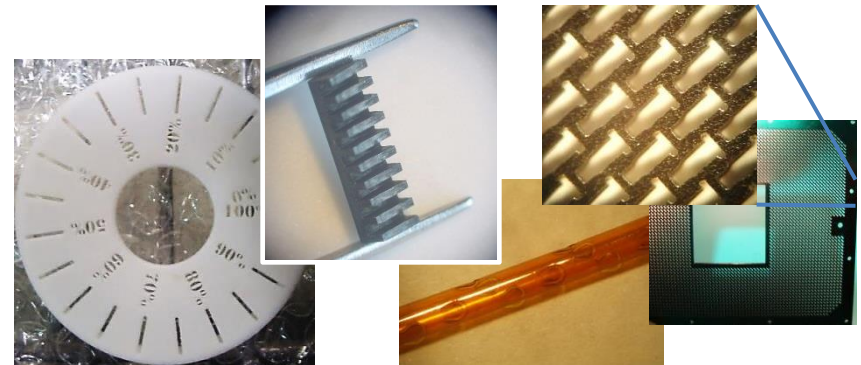
- Non-contact stress
- Smaller Feature Sizes
- Minimal Heat Affect
- No tooling costs
- Leverage Small Lot Sizes
- Reduced Material Waste
- Closer Tolerances
- No Dies/Tooling Wear
- Reduced Finishing Steps



Metals: UV, CO₂, and Fiber lasers are ideal for cutting perfect parts from many types of sheet metal. Laser cutting greatly simplifies the design and manufacturing process to produces intricate detail and very sharp corners.

- | | | |
|-----------|---------|-----------------|
| Cobalt | Nickel | Gold |
| Hastelloy | Brass | Titanium |
| | Nitinol | Platinum |
| | | Carbon Steel |
| | | Stainless Steel |

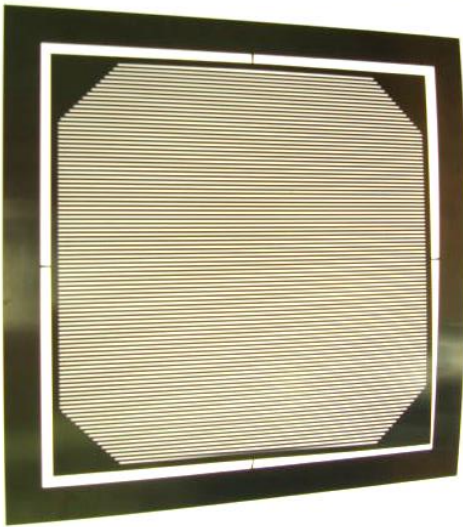
Plastics: Laser machining thermoset plastics and thermoplastics are matched in edge quality, speed, flexibility, and low surface stress. Wavelength selection and power control produce large aspect ratios of 10 to 1 (feature size to material thickness) and reduced heat affected zones (melt and discoloration).



Thermoset and Thermoplastic

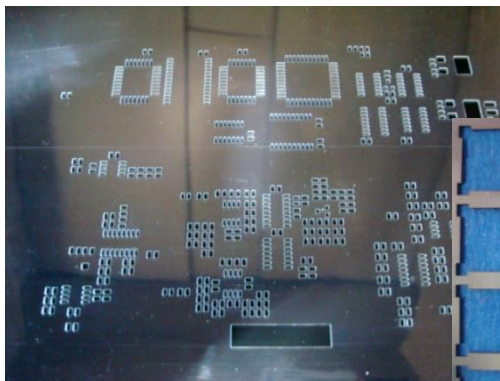
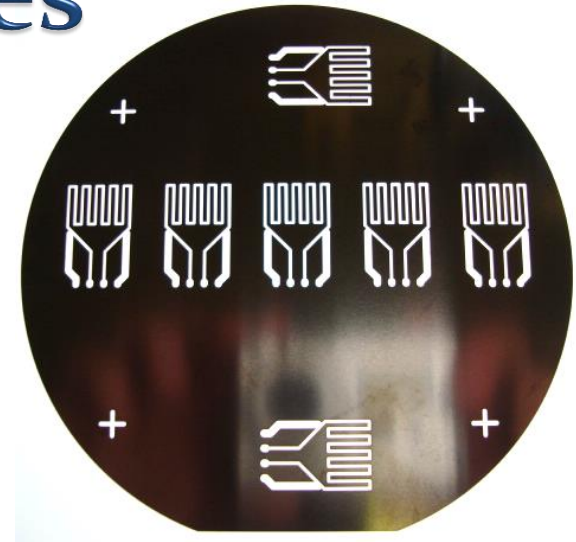
- | | | |
|-----------|--------------|---------------|
| Polyimide | Cirlex | Polycarbonate |
| FR4/G10 | Rubber Based | ABS* |
| PEEK | Acrylic | Polypropylene |

Stencils and Prototypes

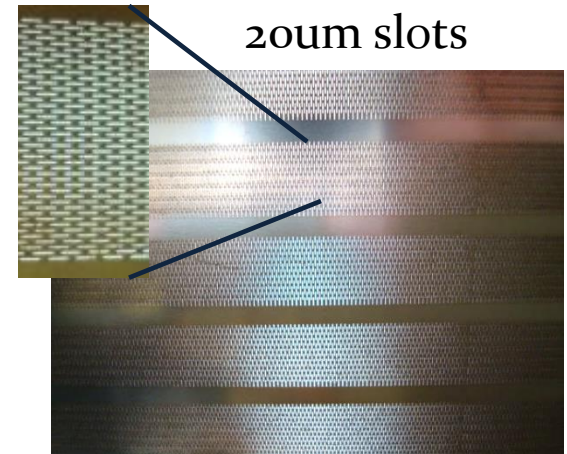
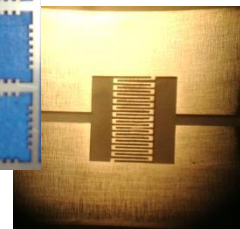
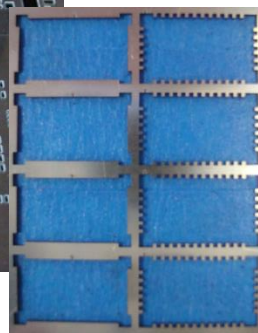


Stainless and Polyimide
Stencil Applications:

- Flux
- Solder Paste
- Rework
- Photomasks /
Shadow Masks



Mylar



Part Marking and Engraving

- Annealed Surface Marks
- Serialization
- Semi and Mil Standards
- Engraving or Scribing



PFA

Plastic Markings



Silicon or Quartz Wafers



Delrin



Anodized Removal Mark

Metal Markings



Precious Metals



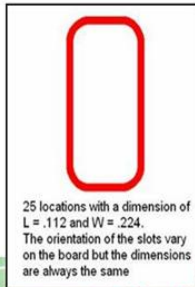
Aluminum



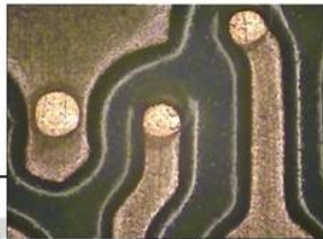
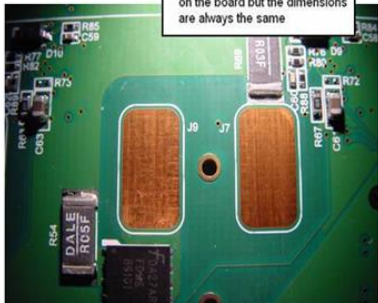
Stainless



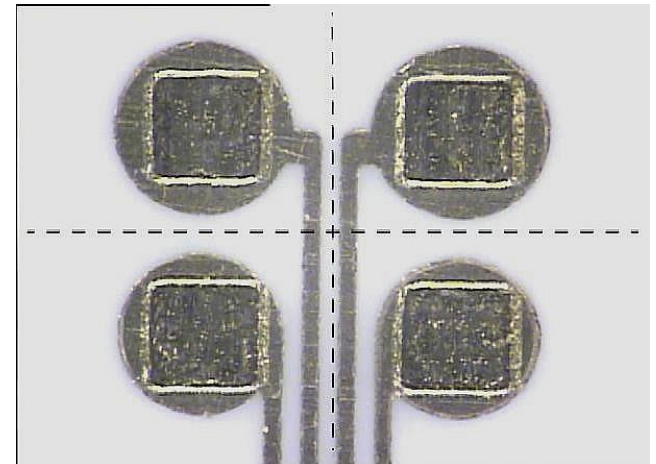
Selective Material Removal



Soldermask Removal



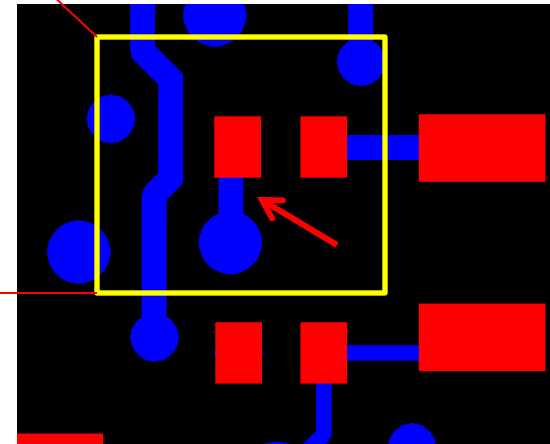
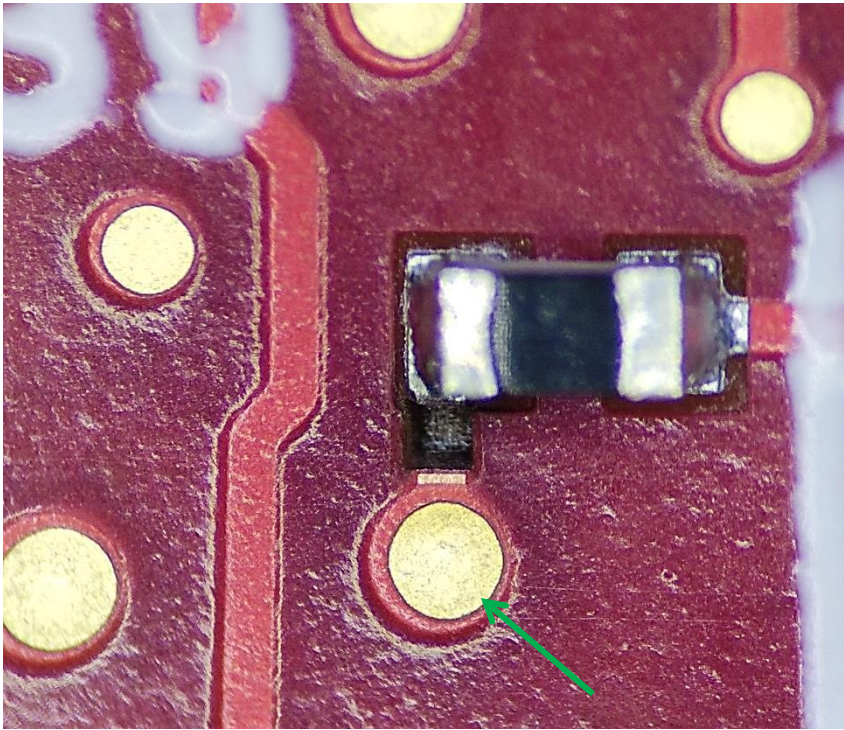
Parylene Ablation



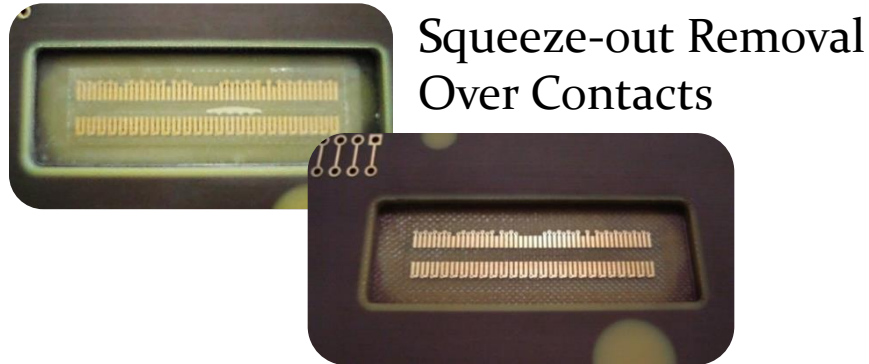
PCB Circuit Rework

Laser circuit repair can:

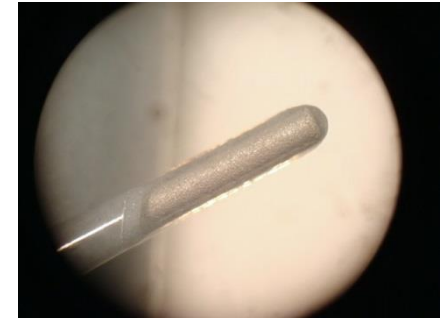
- Severing a trace on the top layer to isolate a pad.
- Inner layer exposure to allow connectivity or repair.
- Design changes eliminating connections and isolating nets.
- Ability to rework bare boards and loaded boards



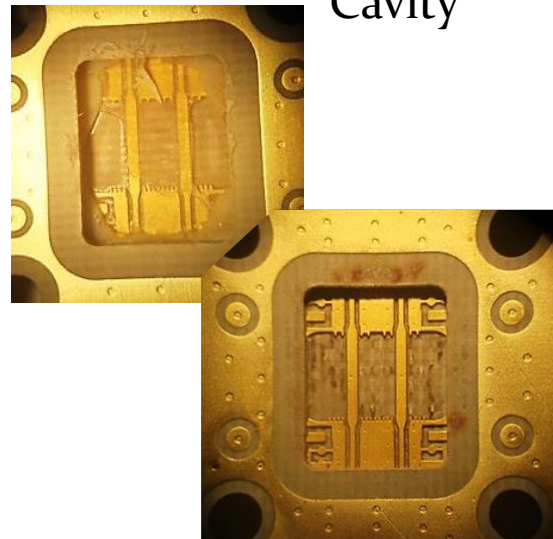
MISCELLANEOUS PCB REWORK



Halar Removal



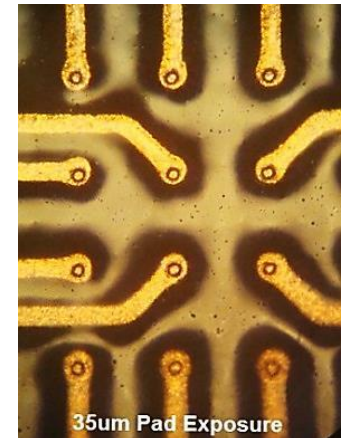
FEP Removal in Cavity



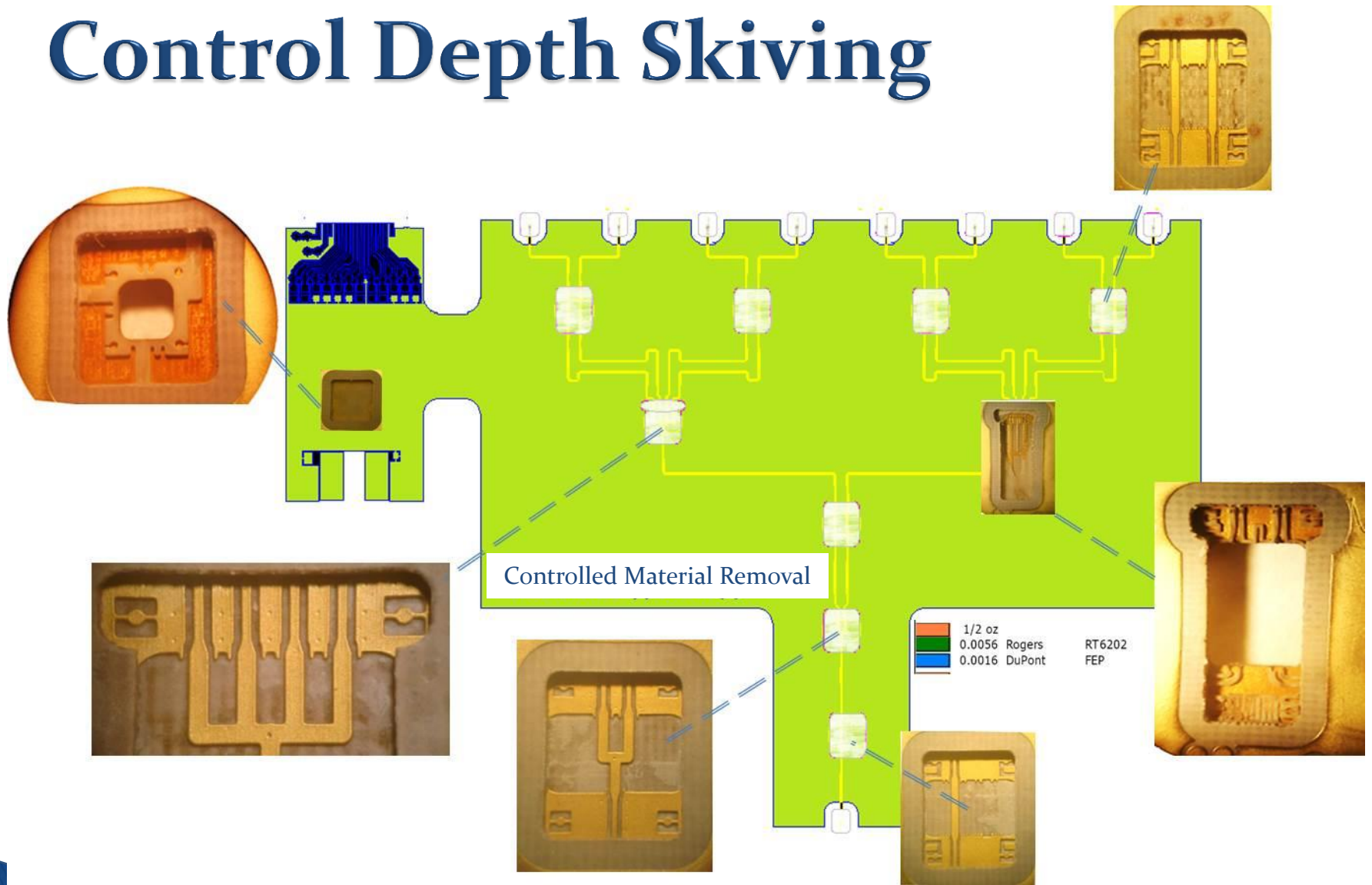
Soldermask Removal Leaving Silk Screen



Kapton Removal



Control Depth Skiving



Quality



- ▶ ITAR Registered and Compliant.
- ▶ **AS9100C / ISO9001:2008 Certified** through QMI-SAI Global.
- ▶ AQL Level Inspection Plan for many applications utilizing Micro-Vu's Excel Multi-sensor Measuring Centers with micron accuracy.
- ▶ Multi-level quality sign-off per lot including programming, setup, first article, lot run, and final inspection.
- ▶ Calibration and maintenance programs.
- ▶ Managed, off-site backup of all data.



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